

HAT2105R

硅 N 沟道功率场效应晶体管
快速电源开关

R07DS0552CJ0200

修订版本 2.00

Dec 05, 2011

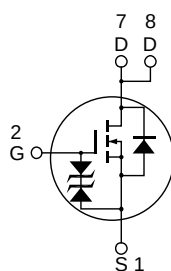
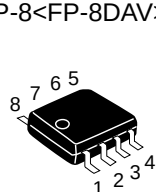
特点

- 低漏极/源极通态电阻
 $R_{DS(on)} = 1.6 \Omega$ 典型值 ($I_D = 0.5 A$, $V_{GS} = 10 V$, $T_a = 25^\circ C$)
- 4 V 栅极驱动能力
- 高密度装配

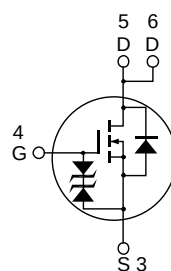
封装形式

RENESAS 封装代码: PRSP0008DD-D

(封装名称: SOP-8<FP-8DAV>)



MOS1



MOS2

1, 3 源极
2, 4 栅极
5, 6, 7, 8 漏极

绝对最大额定值

($T_a = 25^\circ C$)

参数	符号	额定值	单位
漏极/源极电压	V_{DSS}	200	V
栅极/源极电压	V_{GSS}	± 15	V
漏极电流	I_D	0.5	A
脉冲漏极电流	$I_{D(pulse)}$ ^{注1}	2	A
二极管反向漏极电流	I_{DR}	0.5	A
沟道最大容许损耗	P_{ch} ^{注2}	1.3	W
	P_{ch} ^{注3}	2	W
沟道温度	T_{ch}	150	$^\circ C$
储存温度	T_{stg}	-55 to +150	$^\circ C$

- 注:
1. 在 $PW \leq 10 \mu s$, 工作周期 $\leq 1\%$ 的容许值。
 2. 1 驱动操作; 使用玻璃环氧板 (FR4 40 x 40 x 1.6 mm), $PW \leq 10 s$ 的容许值。
 3. 2 驱动操作; 使用玻璃环氧板 (FR4 40 x 40 x 1.6 mm), $PW \leq 10 s$ 的容许值。

电特性

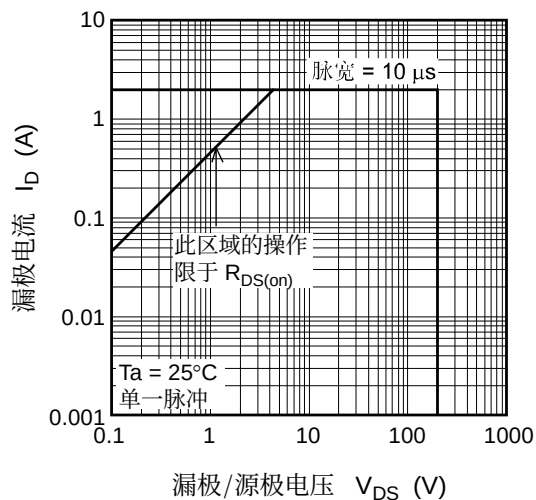
(Ta = 25°C)

参数	符号	最小值	典型值	最大值	单位	测定条件
漏极/源极破坏电压	$V_{(BR)DSS}$	200	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
栅极/源极破坏电压	$V_{(BR)GSS}$	± 15	—	—	V	$I_G = \pm 100 \text{ }\mu\text{A}$, $V_{DS} = 0$
漏极截止电流	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 12 \text{ V}$, $V_{DS} = 0$
栅极截止电流	I_{DSS}	—	—	5	μA	$V_{DS} = 200 \text{ V}$, $V_{GS} = 0$
栅极/源极截止电压	$V_{GS(off)}$	1.0	—	2.1	V	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$
漏极/源极通态电阻	$R_{DS(on)}$	—	1.6	2.2	Ω	$I_D = 0.5 \text{ A}$, $V_{GS} = 10 \text{ V}$ ^{注4}
	$R_{DS(on)}$	—	1.9	2.7	Ω	$I_D = 0.5 \text{ A}$, $V_{GS} = 4 \text{ V}$ ^{注4}
	$R_{DS(on)}$	—	2.4	5.5	Ω	$I_D = 2 \text{ A}$, $V_{GS} = 5 \text{ V}$ ^{注4}
正向传输导纳	$ y_{fs} $	0.56	0.86	—	S	$I_D = 0.5 \text{ A}$, $V_{DS} = 10 \text{ V}$ ^{注4}
输入电容	C_{iss}	—	120	—	pF	$V_{DS} = 10 \text{ V}$, $V_{GS} = 0$, $f = 1 \text{ MHz}$
输出电容	C_{oss}	—	29	—	pF	
反向传输电容	C_{rss}	—	10	—	pF	
接通延迟时间	$t_{d(on)}$	—	10	—	ns	$V_{GS} = 5 \text{ V}$, $I_D = 0.5 \text{ A}$, $V_{DD} \cong 30 \text{ V}$
上升时间	t_r	—	14	—	ns	
关断延迟时间	$t_{d(off)}$	—	24	—	ns	
下降时间	t_f	—	9	—	ns	
体二极管正向电压	V_{DF}	—	0.9	1.4	V	$I_F = 0.5 \text{ A}$, $V_{GS} = 0$ ^{注4}

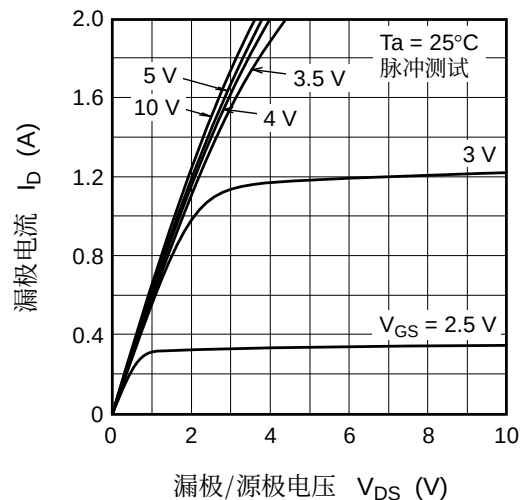
注: 4. 脉冲测试

主要特性

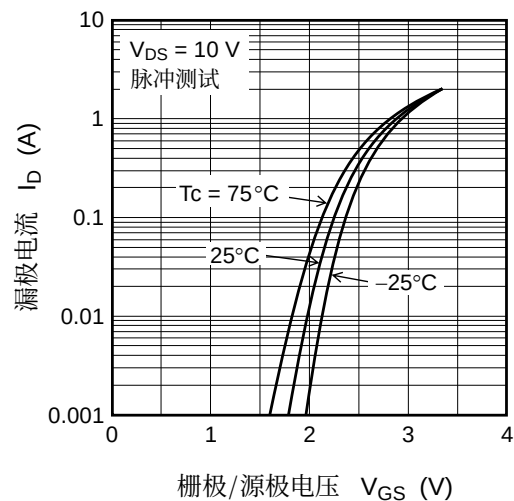
最大安全工作区域



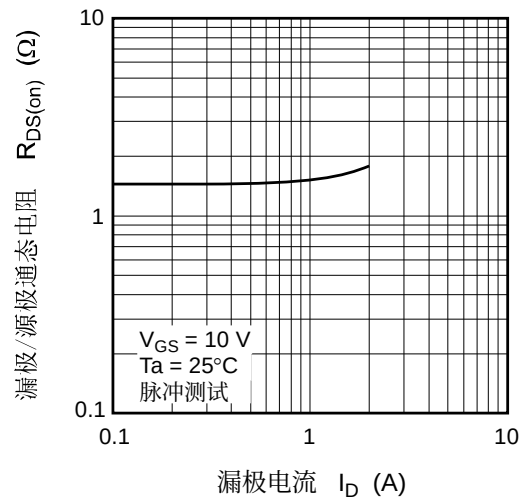
典型输出特性



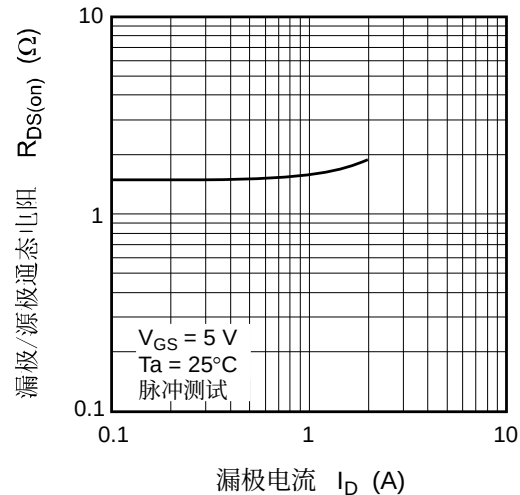
典型传输特性



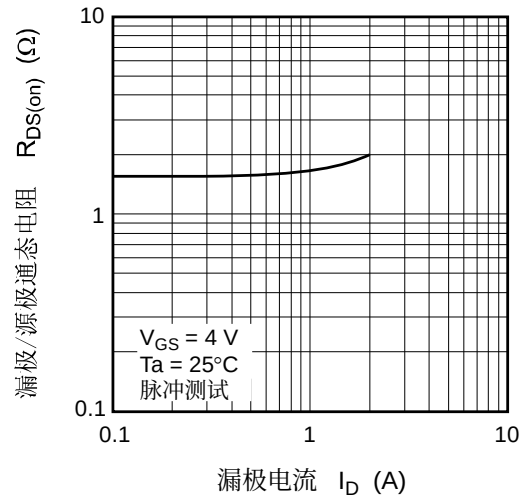
漏极/源极通态电阻-漏极电流 (典型) (1)



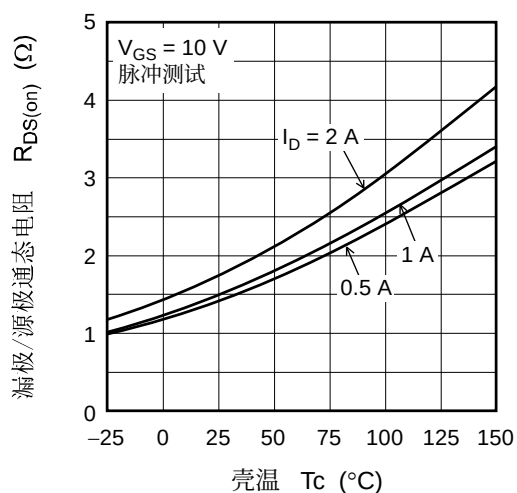
漏极/源极通态电阻-漏极电流 (典型) (2)



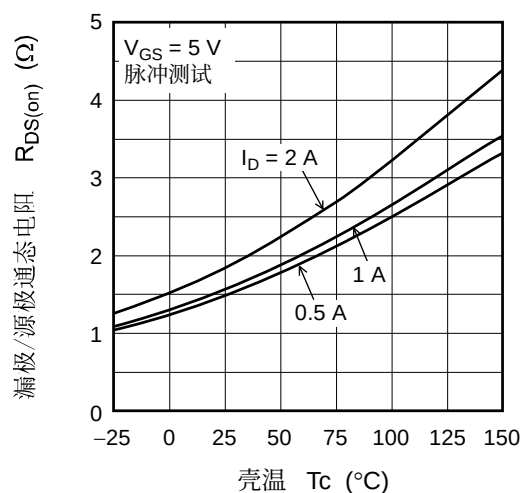
漏极/源极通态电阻-漏极电流 (典型) (3)



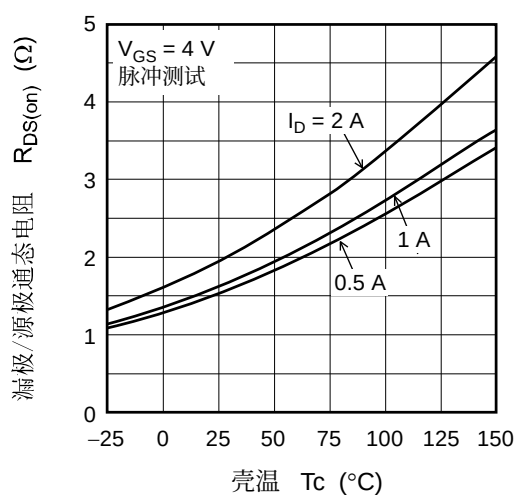
漏极/源极通态电阻-壳温 (典型) (1)



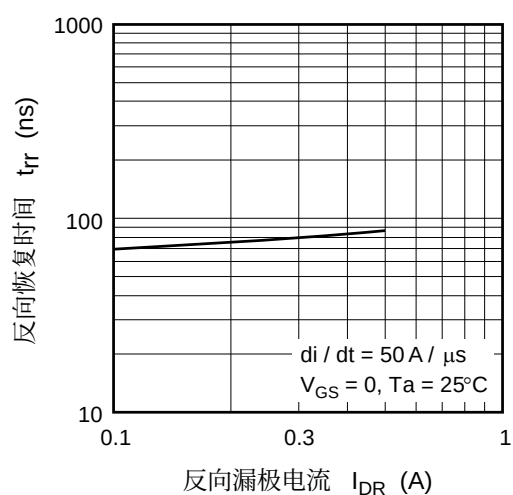
漏极/源极通态电阻-壳温 (典型) (2)



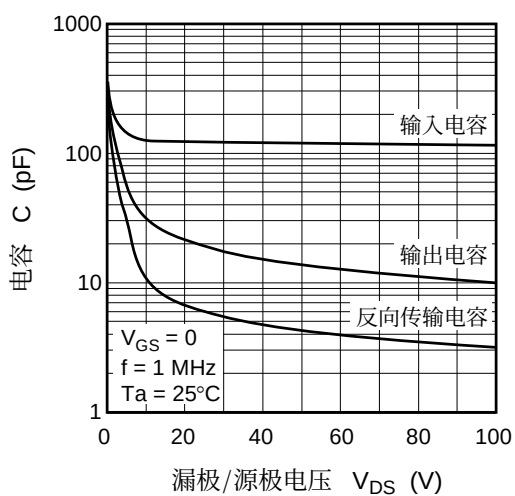
漏极/源极通态电阻-壳温 (典型) (3)



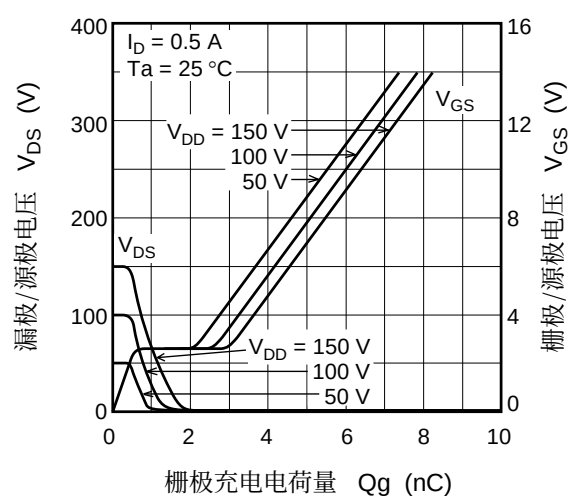
体二极管反向恢复时间 (典型)



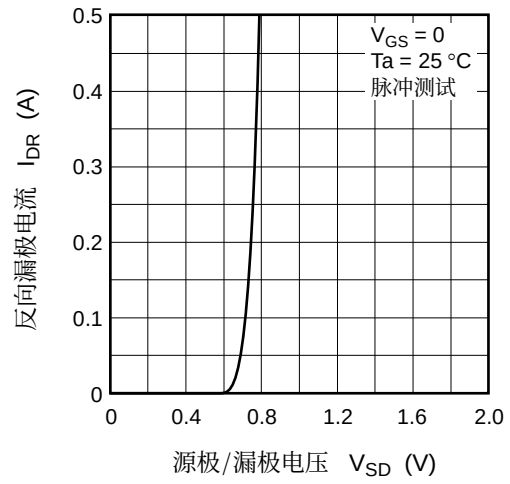
典型电容-漏极/源极电压



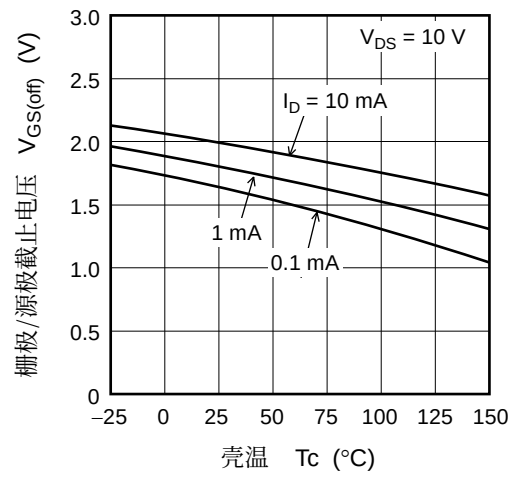
输入时序特性 (典型)



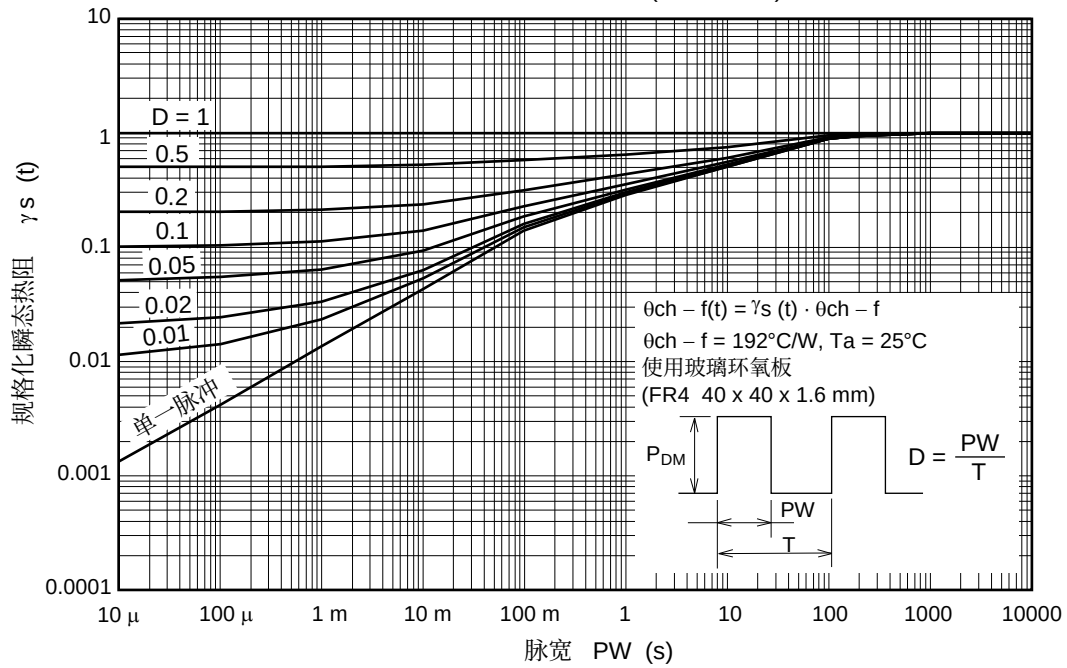
反向漏极电流-源极/漏极电压 (典型)



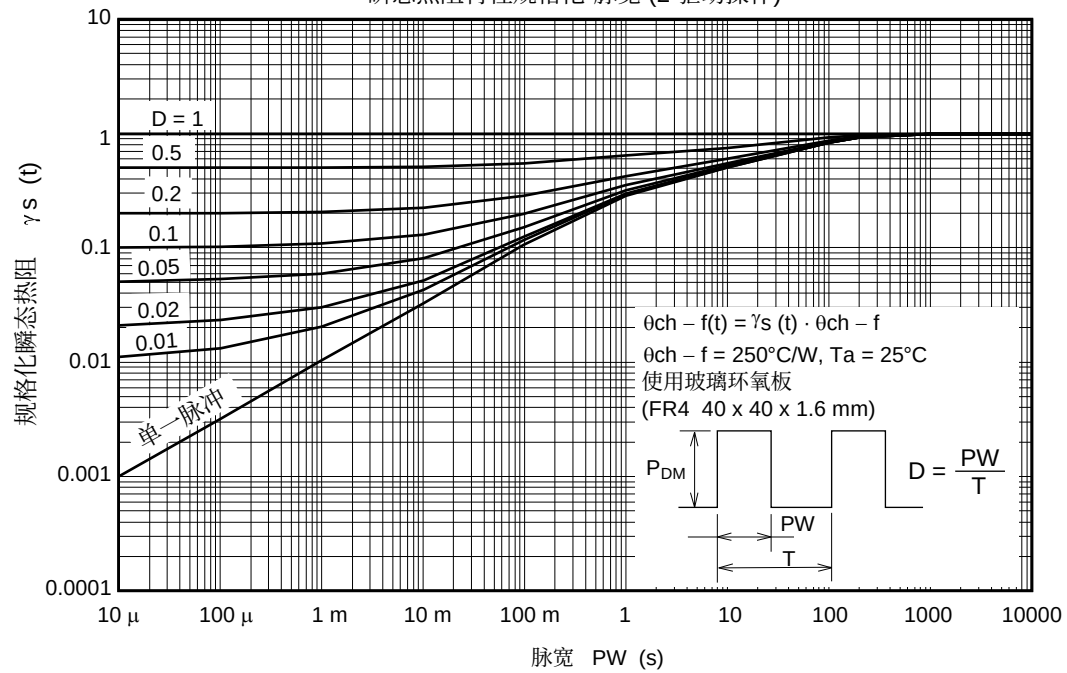
栅极/源极截止电压-壳温 (典型)



瞬态热阻特性规格化-脉宽 (1 驱动操作)

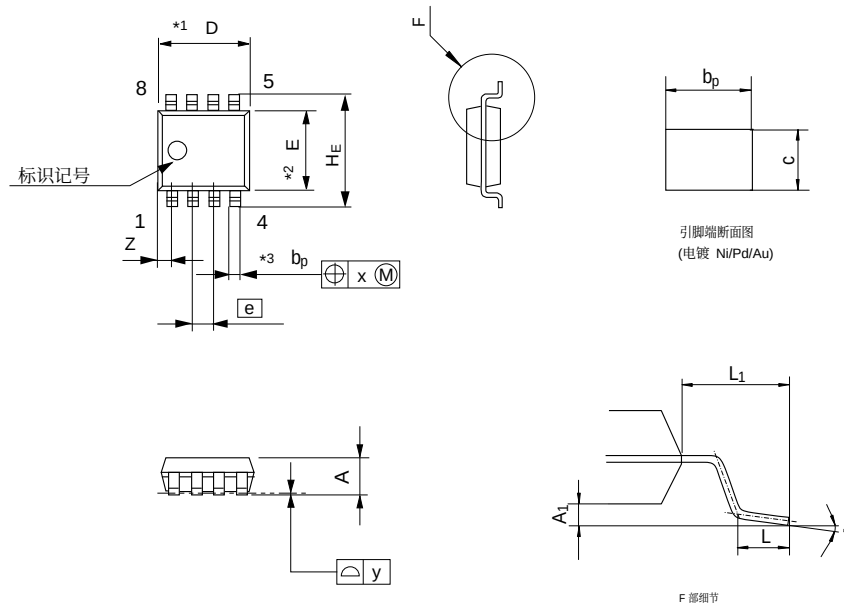


瞬态热阻特性规格化-脉宽 (2 驱动操作)



封装尺寸

封装名称	JEITA 封装代码	RENESAS 代码	旧代码	重量[典型]
SOP-8	P-SOP8-3.95 · 4.9-1.27	PRSP0008DD-D	FP-8DAV	0.085g



注)

1. "1(Nom)" 和 "2" 并不包括溢边尺寸。
2. "3" 并不包括修整失调尺寸。

参考符号	尺寸(单位:mm)		
	Min	Nom	Max
D	—	4.90	5.3
E	—	3.95	—
A ₂	—	—	—
A ₁	0.10	0.14	0.25
A	—	—	1.75
b _D	0.34	0.40	0.46
b ₁	—	—	—
c	0.15	0.20	0.25
C ₁	—	—	—
θ	0°	—	8°
H _E	5.80	6.10	6.20
⊙	—	1.27	—
x	—	—	0.25
y	—	—	0.1
Z	—	—	0.75
L	0.40	0.60	1.27
L ₁	—	1.08	—

订购信息

订购型号	数量	运输包装
HAT2105R-EL#E	2500 枚	带卷包装

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